# 280371-1 - ACTIVE

#### AMPMODU | AMPMODU Headers

TE Internal #: 280371-1 PCB Mount Header, Vertical, Board-to-Board, 4 Position, 2.54 mm [. 1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU Headers

#### View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 4

Number of Rows: 1

### Features

**E T E connectivity** 

### **Product Type Features**

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Partially Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	4
Number of Rows	1
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	750 V
Body Features	
Connector Profile	Standard

**C** For support call+1 800 522 6752

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Contact Eastures		
Contact Features		
PCB Contact Termination Area Plating Material Thickness	3.5 μm	
Contact Shape & Form	Round	
Contact Mating Area Plating Material Finish	Bright	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Phosphor Bronze	
Contact Mating Area Plating Material	Tin	
Contact Type	Pin	
Termination Features		
Termination Post & Tail Length	3.5 mm[.138 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Retention	With	
Panel Mount Feature	Without	
Mating Alignment	With	
Mating Alignment Type	Polarization	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	Thermoplastic	
Dimensions		
Row-to-Row Spacing	2.54 mm[.1 in]	
Usage Conditions		
Housing Temperature Rating	Standard	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Circuit Application	Power & Signal	
Packaging Features		

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Packaging Quantity	1000
Packaging Type	Box, Carton
<b>Product Compliance</b> For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**

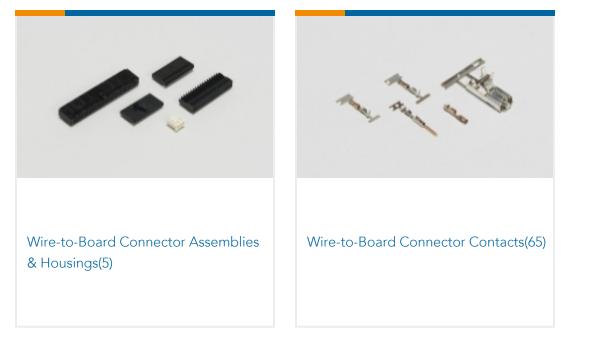


## Also in the Series AMPMODU Headers

PCB Mount Header, Vertical, Board-to-Board, 4 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU Headers







# Customers Also Bought



TE Part #5-102699-9 20 MODII HDR DRST SHRD A/PIN	TE Part #280373-1 8P AMPMODU II SHRD HDR, ST, TIN	TE Part #280379-1 6P AMPMODU II SHRD HDR, RT ANG, TIN	TE Part #280613-1 10P MOD 1 SHROUDED HEADER, ST, TIN PLTD
AND THE REAL PROPERTY OF		THILITE TE	
TE Part #280521-1 2X12P AMPMODU II SHRD HDR, ST, TIN	TE Part #178487-1 UP 3.96 4P TAB HDR NAT TYPE 1	TE Part #280374-1 10P AMPMODU II SHRD HDR, ST, TIN	TE Part #284124-1 2X5P MODU II SHRD HDR,RT ANG, 0.38AU

## Documents

Product Drawings 4P AMPMODU II SHRD HDR, ST, TIN English CAD Files Customer View Model

ENG\_CVM\_CVM\_280371-1\_U\_c-280371-1-u.2d\_dxf.zip

3D PDF

3D

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English

Customer View Model ENG\_CVM\_CVM\_280371-1\_U\_c-280371-1-u.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_280371-1\_U\_c-280371-1-u.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance Product Compliance Document

English

Product Compliance Document

English